

# SANYO Semiconductors DATA SHEET



# N-Channel Silicon MOSFET ECH8616 — General-Purpose Switching Device **Applications**

# **Features**

- · Ultrahigh-speed switching.
- 4V drive.
- · Composite type, facilitating high-density mounting.

# Specifications

#### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		60	V
Gate-to-Source Voltage	VGSS		±20	V
Drain Current (DC)	۱D		3	А
Drain Current (Pulse)	IDP	PW≤10µs, duty cycle≤1%	20	А
Allowable Power Dissipation	PD	Mounted on a ceramic board (900mm <sup>2</sup> X0.8mm) 1unit	1.3	W
Total Dissipation	PT	Mounted on a ceramic board (900mm <sup>2</sup> X0.8mm)	1.5	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

#### Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Linit	
			min	typ	max	Unit	
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0	60			V	
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =60V, V <sub>GS</sub> =0			1	μΑ	
Gate-to-Source Leakage Current	IGSS	VGS=±16V, VDS=0			±10	μΑ	
Cutoff Voltage	V <sub>GS</sub> (off)	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	1.2		2.6	V	
Forward Transfer Admittance	yfs	V <sub>DS</sub> =10V, I <sub>D</sub> =1.5A	2.2	3.8		S	
Static Drain-to-Source On-State Resistance	RDS(on)1	ID=1.5A, VGS=10V		70	93	mΩ	
	R <sub>DS</sub> (on)2	ID=0.5A, VGS=4V		92	133	mΩ	
Input Capacitance	Ciss	V <sub>DS</sub> =20V, f=1MHz		560		pF	
Output Capacitance	Coss	VDS=20V, f=1MHz		60		pF	
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =20V, f=1MHz		41		pF	
Turn-ON Delay Time	t <sub>d</sub> (on)	See specified Test Circuit.		11		ns	
Rise Time	tr	See specified Test Circuit.		11		ns	
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit.		61		ns	
Fall Time	tf	See specified Test Circuit.		32		ns	
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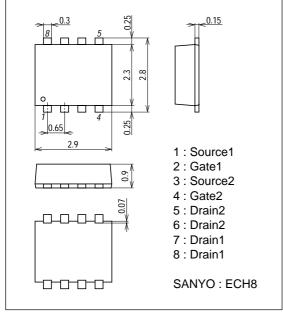
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Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Total Gate Charge	Qg	VDS=30V, VGS=10V, ID=3A		12.8		nC
Gate-to-Source Charge	Qgs	V <sub>DS</sub> =30V, V <sub>GS</sub> =10V, I <sub>D</sub> =3A		2.1		nC
Gate-to-Drain "Miller" Charge	Qgd	VDS=30V, VGS=10V, ID=3A		2.7		nC
Diode Forward Voltage	VSD	IS=3A, VGS=0		0.81	1.2	V

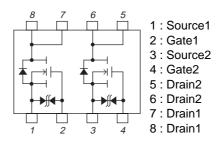
## **Package Dimensions**

unit : mm

2206B

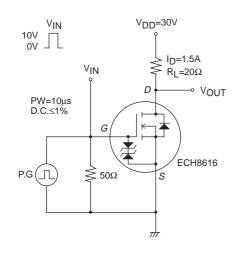


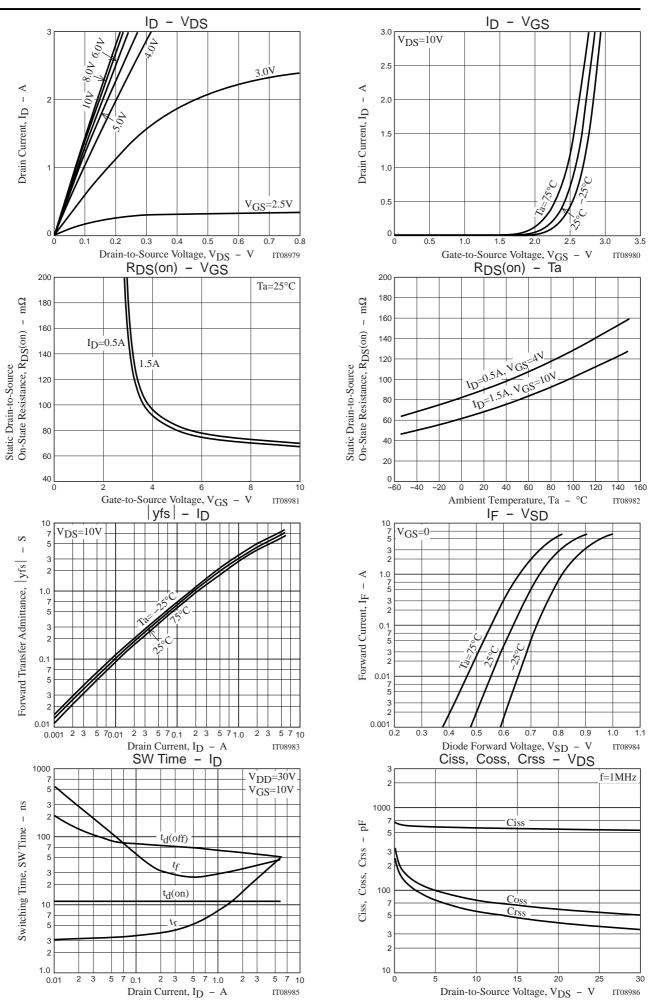
## **Electrical Connection**

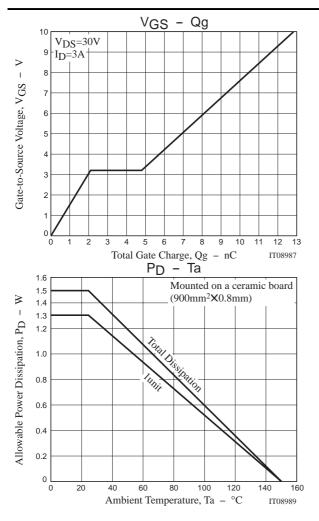


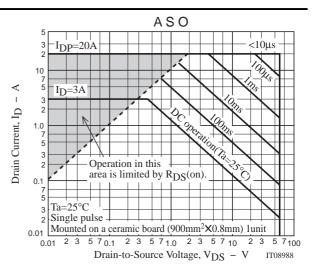
Top view

# Switching Time Test Circuit









Note on usage : Since the ECH8616 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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